# MOS FIELD EFFECT TRANSISTOR NP100P06PLG

## SWITCHING P-CHANNEL POWER MOSFET

## DESCRIPTION

NEC

The NP100P06PLG is P-channel MOS Field Effect Transistor designed for high current switching applications.

## <R> ORDERING INFORMATION

PART NUMBER	LEAD PLATING	PACKING	PACKAGE
NP100P06PLG-E1-AY Note		Taxa 000 a/aal	
NP100P06PLG-E2-AY Note	Pure Sn (Tin)	Tape 800 p/reel	TO-263 (MP-25ZP)

**Note** Pb-free (This product does not contain Pb in external electrode.)

## FEATURES

Super low on-state resistance

 $R_{DS(on)1} = 6.0 \text{ m}\Omega \text{ MAX.} (V_{GS} = -10 \text{ V}, \text{ ID} = -50 \text{ A})$ 

 $R_{\text{DS(on)2}}$  = 7.8 m $\Omega$  MAX. (Vgs = -4.5 V, ID = -50 A)

- High current rating: I<sub>D(DC)</sub> = ∓100 A
- Built-in gate protection diode

#### ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Drain to Source Voltage (VGs = 0 V)	VDSS	-60	V
Gate to Source Voltage (VDs = 0 V)	Vgss	∓20	V
Drain Current (DC) (Tc = 25°C)	ID(DC)	<b>∓100</b>	А
Drain Current (pulse) <sup>Note1</sup>	D(pulse)	∓300	А
Total Power Dissipation (Tc = 25°C)	<b>P</b> T1	200	W
Total Power Dissipation (T <sub>A</sub> = 25°C)	Pt2	1.8	W
Channel Temperature	Tch	175	°C
Storage Temperature	Tstg	-55 to +175	°C
Single Avalanche Current Note2	las	64	А
Single Avalanche Energy Note2	Eas	420	mJ

**Notes 1.** PW  $\leq$  10  $\mu$ s, Duty Cycle  $\leq$  1%

2. Starting T<sub>ch</sub> = 25°C, V<sub>DD</sub> = -30 V, R<sub>G</sub> = 25  $\Omega$ , V<sub>GS</sub> = -20  $\rightarrow$  0 V

#### THERMAL RESISTANCE

Channel to Case Thermal Resistance	Rth(ch-C)	0.75	°C/W
Channel to Ambient Thermal Resistance	Rth(ch-A)	83.3	°C/W

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(TO-263)

The mark <R> shows major revised points. The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what:" field.

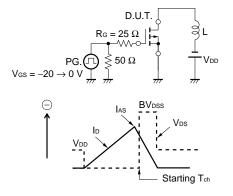
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	loss	V <sub>DS</sub> = -60 V, V <sub>GS</sub> = 0 V			-10	μA
Gate Leakage Current	Igss	V <sub>GS</sub> = ∓20 V, V <sub>DS</sub> = 0 V			∓10	μA
Gate to Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}$ = -10 V, I <sub>D</sub> = -1 mA	-1.0	-1.6	-2.5	V
Forward Transfer Admittance Note	y <sub>fs</sub>	V <sub>DS</sub> = -10 V, I <sub>D</sub> = -50 A	43	86		S
Drain to Source On-state Resistance Note	RDS(on)1	Vgs = -10 V, Id = -50 A		4.4	6.0	mΩ
	RDS(on)2	Vgs = -4.5 V, Id = -50 A		5.0	7.8	mΩ
Input Capacitance	Ciss	V <sub>DS</sub> = -10 V,		15000		pF
Output Capacitance	Coss	V <sub>GS</sub> = 0 V,		1810		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		840		pF
Turn-on Delay Time	td(on)	$V_{DD} = -30 \text{ V}, \text{ I}_{D} = -50 \text{ A},$		28		ns
Rise Time	tr	V <sub>GS</sub> = -10 V,		35		ns
Turn-off Delay Time	td(off)	R <sub>G</sub> = 0 Ω		275		ns
Fall Time	tr			100		ns
Total Gate Charge	Q <sub>G</sub>	Vdd = -48 V,		300		nC
Gate to Source Charge	Q <sub>GS</sub>	V <sub>GS</sub> = -10 V,		35		nC
Gate to Drain Charge	Qgd	I <sub>D</sub> = -100 A		85		nC
Body Diode Forward Voltage Note	V <sub>F(S-D)</sub>	IF = -100 A, VGS = 0 V		0.92	1.5	V
Reverse Recovery Time	trr	IF = -100 A, VGS = 0 V,		70		ns
Reverse Recovery Charge	Qrr	di/dt = −100 A/ <i>μ</i> s		135		nC

#### ELECTRICAL CHARACTERISTICS (TA = 25°C)

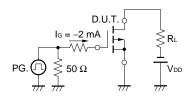
**Note** Pulsed test PW  $\leq$  350  $\mu$ s, Duty Cycle  $\leq$  2%

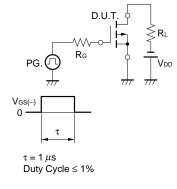
#### TEST CIRCUIT 1 AVALANCHE CAPABILITY

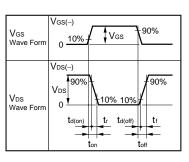
#### **TEST CIRCUIT 2 SWITCHING TIME**



#### TEST CIRCUIT 3 GATE CHARGE







100 125 150 175 200

Tc - Case Temperature - °C

TOTAL POWER DISSIPATION vs.

CASE TEMPERATURE

240

200

160

120

80

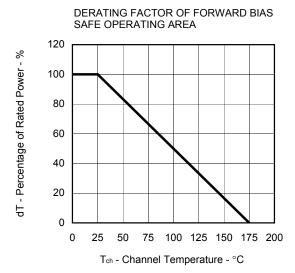
40

0

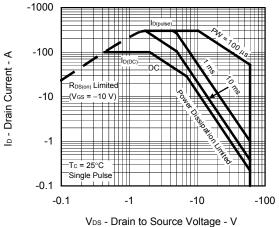
0 25 50 75

 $\mathsf{P}_{\mathsf{T}}$  - Total Power Dissipation - W

## TYPICAL CHARACTERISTICS (TA = 25°C)

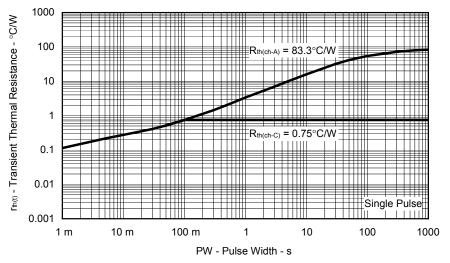






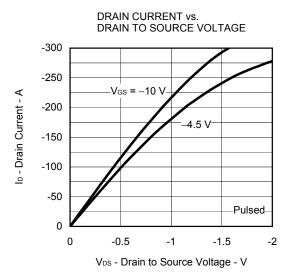


#### TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

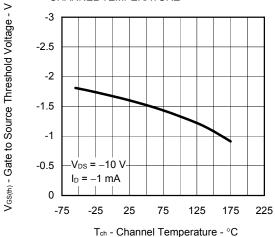


Data Sheet D18695EJ3V0DS

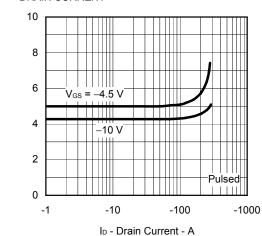




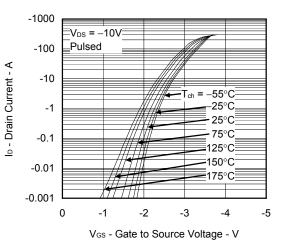




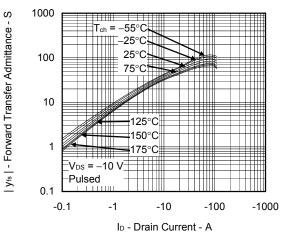
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



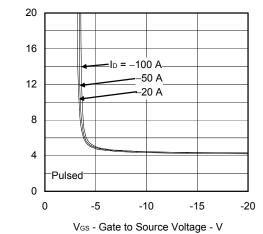




FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT

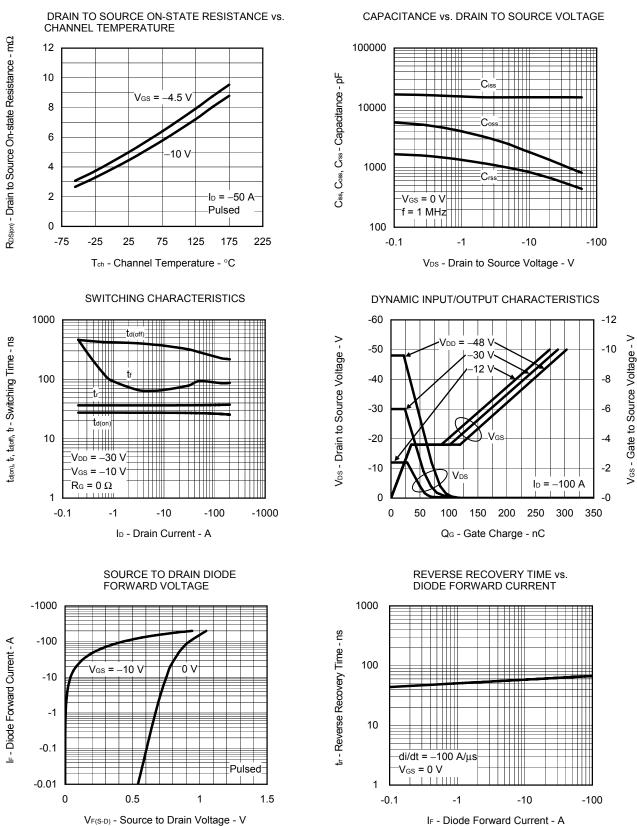


DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



 $R_{DS(m)}$  - Drain to Source On-state Resistance -  $m\Omega$ 

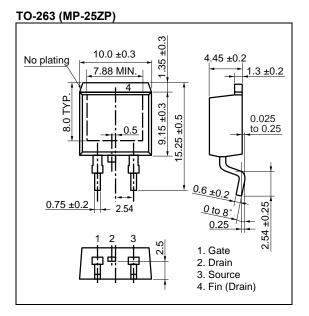
 $R_{\text{DS}(\text{on})}$  - Drain to Source On-state Resistance -  $m\Omega$ 



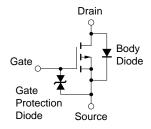
VF(S-D) - Source to Drain Voltage - V

Data Sheet D18695EJ3V0DS

## PACKAGE DRAWING (Unit: mm)



## EQUIVALENT CIRCUIT



**Remark** The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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